

Silicon PIN Diode Array

- Surge protection device
- Designed for surge overvoltage clamping in antiparallel connection
- Pb-free (RoHS compliant) package¹⁾
- Qualified according AEC Q101





BAR66



Туре	Package	Configuration	L_S (nH)	Marking
BAR66	SOT23	series	1.8	PMs

Maximum Ratings at $T_A = 25^{\circ}$ C, unless otherwise specified

Parameter	Symbol	Value	Unit	
Diode reverse voltage	V _R	150	V	
Forward current	I _F	200	mA	
Total power dissipation	P _{tot}	250	mW	
$T_{\rm S} \le 25 \ {\rm ^{\circ}C}$				
ESD contact discharge ²⁾	V _{ESD}	25	kV	
Peak pulse current ($t_p = 8 / 20 \ \mu s$) ³⁾	I _{pp}	12	А	
Junction temperature	Tj	150	°C	
Operating temperature range		-55 125		
Storage temperature	T _{stg}	-55 150		

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ⁴⁾ , BAR 66	R _{thJS}	≤ 290	K/W

¹Pb-containing package may be available upon special request

 $^2\text{V}_{\mbox{ESD}}$ according to IEC61000-4-2, only valid if pin 1 and pin 2 are connected

 $^{3}\textit{I}_{pp}$ according to IEC61000-4-5, only valid if pin 1 and pin 2 are connected

⁴For calculation of R_{thJA} please refer to Application Note Thermal Resistance



Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics	•	•	•	•	
Breakdown voltage	V _(BR)	150	-	-	V
$I_{(BR)} = 5 \ \mu A$					
Reverse current	l _R	-	-	20	nA
V _R = 100 V					
Forward voltage	V _F	-	0.95	1.2	V
<i>I</i> _F = 50 mA					
Clamping voltage	V _{CL}				
$V_{\text{ESD}} = \pm 15 \text{ kV} \text{ (contact)}^{1)}$		-	tbd	-	
$I_{\rm PP}$ = 12 A, $t_{\rm p}$ = 8/20 µs ²⁾		-	7	-	
AC Characteristics					
Diode capacitance	CT				pF
$V_{\rm R} = 35 {\rm V}, f = 1 {\rm MHz}$		-	0.4	0.6	
$V_{\rm R} = 0 \text{ V}, f = 100 \text{ MHz}$		-	0.35	0.9	
Zero bias conductance	g _P	-	220	-	μS
$V_{\rm R} = 0 {\rm V}, f = 1 {\rm GHz}$					
Forward resistance	r _f	-	1.5	1.8	Ω
<i>I</i> _F = 5 mA, <i>f</i> = 100 MHz					
Charge carrier life time	τ _{rr}	-	0.7	-	μs
$I_{\rm F}$ = 10 mA, $I_{\rm R}$ = 6 mA, measured at $I_{\rm R}$ = 3 mA,					
$R_{\rm L}$ = 100 Ω					

Electrical Characteristics at $T_A = 25^{\circ}C$, unless otherwise specified

 $^{1}V_{\text{ESD}}$ according to IEC61000-4-2, only valid if pin 1 and pin 2 are connected

 $^2\textit{I}_{pp}$ according to IEC61000-4-5, only valid if pin 1 and pin 2 are connected



Diode capacitance $C_{T} = f(V_{R})$

f = Parameter



Forward resistance $r_{\rm f} = f (I_{\rm F})$

f = 100 MHz



Forward current $I_{\rm F} = f (V_{\rm F})$

 T_A = Parameter



Forward current $I_{F} = f(T_{S})$ BAR66





Permissible Puls Load $R_{\text{thJS}} = f(t_{\text{p}})$ BAR66



Permissible Pulse Load

 $I_{\text{Fmax}}/I_{\text{FDC}} = f(t_{\text{p}})$

BAR66









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